2.5V Drive Pch MOSFET

RTF010P02

Structure

Silicon P-channel MOSFET

● Features

- 1) Low on-resistance. (570m Ω at 2.5V)
- 2) High power package.
- 3) High speed switching.
- 4) Low voltage drive. (2.5V)

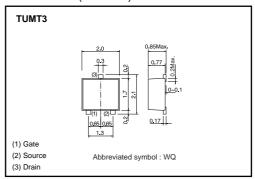
Applications

DC-DC converter

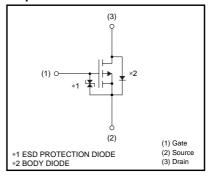
Packaging specifications

	Package	Taping	
Type	Code	TL	
	Basic ordering unit (pieces)	3000	
RTF010P02		0	

●Dimensions (Unit:mm)



●Equivalent circuit



● Absolute maximum ratings (Ta=25°C)

Parameter		Symbol	Limits	Unit
Drain-source voltage		V _{DSS}	-20	V
Gate-source voltage		V _{GSS}	±12	V
Drain current	Continuous	ID	±1	Α
	Pulsed	I _{DP} *1	±4	Α
Source current	Continuous	Is *1	-0.4	Α
(Body diode)	Pulsed	I _{SP}	-4	Α
Total power dissipation		P _D *2	0.8	W
Channel temperature		Tch	150	°C
Range of Storage temperature		Tstg	-55 to +150	°C

^{*1} Pw≤10µs, Duty cycle≤1% *2 Mounted on a ceramic board

●Thermal resistance

Parameter	Symbol	Limits	Unit
Channel to ambient	Rth(ch-a) *	156	°C / W

^{*} Mounted on a ceramic board.

●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	Igss	-	-	±10	μΑ	Vgs=±12V, Vps=0V
Drain-source breakdown voltage	$V_{(BR)\;DSS}$	-20	_	_	V	I _D = -1mA, V _{GS} =0V
Zero gate voltage drain current	I _{DSS}	-	_	-1	μΑ	V _{DS} = -20V, V _{GS} =0V
Gate threshold voltage	V _{GS (th)}	-0.7	_	-2.0	V	$V_{DS}=-10V$, $I_{D}=-1mA$
Otatia duain accuracy au atata	*	_	280	390	mΩ	I _D = -1A, V _G S= -4.5V
Static drain-source on-state resistance	R _{DS (on)}	-	310	430	mΩ	I _D = -1A, V _G S= -4V
resistance		-	570	800	mΩ	I _D = -0.5A, V _G S= -2.5V
Forward transfer admittance	Y _{fs} *	0.7	_	_	S	V _{DS} = -10V, I _D = -0.5A
Input capacitance	Ciss	-	150	_	pF	V _{DS} = -10V
Output capacitance	Coss	_	20	_	pF	Vgs=0V
Reverse transfer capacitance	Crss	_	20	_	pF	f=1MHz
Turn-on delay time	t _{d (on)} *	_	9	_	ns	ID= -0.5A
Rise time	tr *	_	8	_	ns	VDD≒ -15V
Turn-off delay time	td (off) *	_	25	_	ns	V _{GS} = -4.5V R _L =30Ω
Fall time	t _f *	-	10	_	ns	R _G =10Ω
Total gate charge	Qg *	_	2.1	_	nC	V _{DD} ≒−15V R _L =15Ω
Gate-source charge	Q _{gs} *	_	0.5	-	nC	$V_{GS} = -4.5V$ R _G =10 Ω
Gate-drain charge	Q _{gd} *	_	0.5	_	nC	I _D =-1A

^{*}Pulsed

●Body diode characteristics (Source -drain) (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	Vsp	_	_	-1.2	V	I _S = -0.4A, V _{GS} =0V

•Electrical characteristic curves

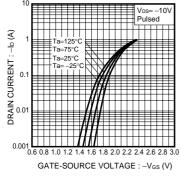


Fig.1 Typical Transfer Characteristics

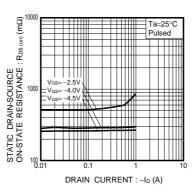


Fig.2 Static Drain-Source On-State Resistance vs. Drain Current

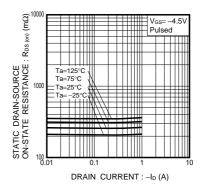


Fig.3 Static Drain-Source On-State Resistance vs. Drain Current

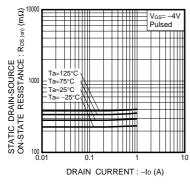


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current

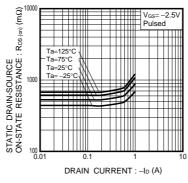


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current

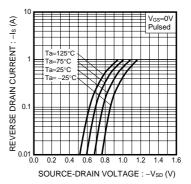


Fig.6 Reverse Drain Current vs. Source-Drain Voltage

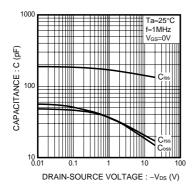


Fig.7 Typical Capacitance vs. Drain-Source Voltage

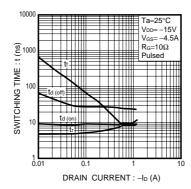


Fig.8 Switching Characteristics

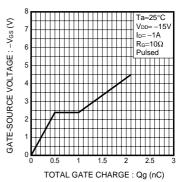


Fig.9 Dynamic Input Characteristics

Measurement circuits

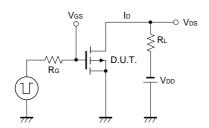


Fig.10 Switching Time Measurement Circuit

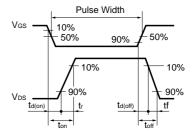


Fig.11 Switching Waveforms

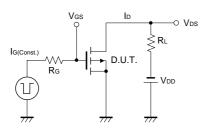


Fig.12 Gate Charge Measurement Circuit

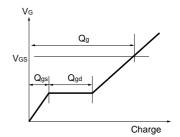


Fig.13 Gate Charge Waveforms

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